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NXP, B.V. NXP INTELLECTUAL PROPERTY & LICENSING M/S41-SJ 1109 MCKAY DRIVE SAN JOSE, CA 95131			EXAMINER PARIKH, KALPIT	
			ART UNIT 2187	PAPER NUMBER
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Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

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Office Action Summary	Application No. 10/538,456	Applicant(s) OMATHUNA, PADRAIG	
	Examiner KALPIT PARIKH	Art Unit 2187	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 17 September 2009.
- 2a) ☒ This action is **FINAL**. 2b) ☐ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-18 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1-18 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
 2. ☐ Certified copies of the priority documents have been received in Application No. _____.
 3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|--|---|
| 1) <input checked="" type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____ |
| 2) <input type="checkbox"/> Notice of Draftperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO/SB/08)
Paper No(s)/Mail Date _____ | 6) <input type="checkbox"/> Other: _____ |

DETAILED ACTION

The instant detailed action is in response to Applicant's submission filed on 17 September 2009.

I. APPLICATION INFORMATION

Application No. 10/538456 has a total of 18 claims pending in the application; there are 3 independent claims and 15 dependent claims, all of which are ready for examination by the examiner.

II. REJECTIONS NOT BASED ON PRIOR ART

Drawings

The drawings are objected to under 37 CFR 1.83(a). The drawings must show every feature of the invention specified in the claims. Therefore, the plurality of integrated circuits (ICs) disposed on a substrate and communicatively coupled to one another through test circuitry that provides debugging capabilities, and transmitting, using the test circuitry, the second set of programming instructions to a second one of the plurality of ICs must be shown or the feature(s) canceled from the claim(s). No new matter should be entered. Examiner notes FIG 4- 8 show boxes and reference numerals but do not illustrate the claimed subject matter because they do not label the contents of each box.

III. REJECTIONS BASED ON PRIOR ART

Claim Rejections - 35 USC § 103

1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

2. **CLAIMS 1-14** rejected under 35 U.S.C. 103(a) as being unpatentable over Yamada (US Pat No. 5757639) in view of Stancil (US Pat No. 6272584) and May (US Pat No. 7343483).

As per claim 1, Yamada discloses a method of transferring programming instructions from a first memory disposed on a substrate, to a plurality of integrated circuits (ICs), comprising:

- a first one of the plurality of ICs (see Yamada FIG 1: 1 MASTER CPU) accessing the first memory (see FIG 6: S2), retrieving a first set of programming instructions, and storing the first set of programming instructions within the first one of the plurality of ICs (see Yamada FIG 6: S3 and COL 3 LINES 32-46); and
- the first one of the plurality of ICs accessing the first memory, retrieving a second set of programming instructions, and transmitting the second set of programming instructions to a second one of the plurality of ICs (see Yamada FIG 6: S5 and COL 3 LINES 32-46).

However, Yamada does not expressly disclose the memory and the plurality of integrated circuit (ICs) are disposed on the substrate.

In the same field of endeavor Stancil discloses it is well known to place many components on a motherboard (substrate) (see Stancil COL 5 LINES 5-10).

It would have been obvious to modify Yamada to integrate the components on a motherboard.

The suggestion/motivation for doing so would have been of higher performance system s (see Stancil COL 2 LINES 24-28).

Therefore it would have been obvious to modify Yamada to integrate the components on a motherboard for the benefit higher performance to arrive at the invention as specified in the claims.

However, Yamada and Stancil does not expressly disclose

- communicatively coupled to one another through test circuitry that provides debugging capabilities,
- transmitting, using the test circuitry, the second set of programming instructions to a second one of the plurality of ICs.

In the same filed of endeavor May discloses

- communicatively coupled to one another through test circuitry that provides debugging capabilities (see May FIG 2: 240),

[The embedded controller is construed as a first integrated circuit and the PLD array is construed as the second integrated circuit.]

- transmitting, using the test circuitry, the second set of programming instructions to a second one of the plurality of ICs (see May COL 3 LINES 24-41).

It would have been obvious to modify Yamada and Stancil to communicatively couple the first and second integrated circuit through test circuitry as taught by May.

The suggestion/motivation for doing so would have been for the benefit of a test interface (see FIG 2: 'PLD TEST INTERFACE').

Therefore it would have been obvious to modify Yamada and Stancil to communicatively couple the first and second integrated circuit through test circuitry as taught by May for the benefit of a test interface to arrive at the invention as specified in the claims.

As per claim 2, Yamada in view of Stancil and May disclose the method of Claim 1,

- wherein the first and second ones of the plurality of ICs each comprise a processor capable of executing, respectively, the first and second sets of programming instructions (see Yamada FIG 6: S3, S5: 'PROGRAM DATA') and
- further including the step of debugging the plurality of ICs using the test circuitry by operating the test circuitry in a test mode (see May FIG 2: PLD TEST INTERFACE) and
- wherein each of the steps of accessing retrieving, storing and transmitting is implemented when the test circuitry is in a mode other than the test mode (see May COL 13 LINES 24-41).

As per claim 3, Yamada in view of Stancil and May disclose the method of Claim 2, further comprising

- the first one of the plurality of ICs executing at least a portion of the first set of programming instructions (see Yamada COL 3 LINES 45-55);
- in a test mode, operating the test circuitry using control signals from a source external to the substrate (see May FIG 2: PLD TEST INTERFACE) and
- in a mode other than the test mode, operating the test circuitry using control signals generated on the substrate (see May COL 13 LINES 24-41).

As per claim 4, Yamada in view of Stancil and May disclose the method of Claim 3,

- wherein executing at least a portion of the first set of programming instructions occurs prior to transmitting the second set of programming instructions to a second one of the plurality of ICs (see Yamada FIG 6: S3, S5).

As per claim 5, Yamada in view of Stancil and May disclose the method of Claim 2,

- further comprising the first one of the plurality of ICs accessing the first memory, retrieving a first set of data, and storing the first set of data within the first one of the plurality of ICs; and the first one of the plurality of ICs accessing the first memory, retrieving a second set of data, and transmitting the second set of data to a second one of the plurality of ICs (see Yamada FIG 6: S3, S5).

As per claim 6, Yamada in view of Stancil and May disclose the method of Claim 3,

- wherein the substrate comprises a printed circuit board (see Stancil COL 2 LINE 25: "motherboard"), and

- the test circuitry of each of the plurality of ICs has an input for a test mode signal (see May FIG 2: PLD TEST INTERFACE) and a clock that is common to each of the plurality of ICs (see May FIG 2: JTAG).

As per claim 7, Yamada in view of Stancil and May disclose the method of Claim 3,

- wherein transmitting comprises serially shifting data out from the first integrated circuit and concurrently shifting data in to the second integrated circuit (see Yamada FIG 6: S5 "SERIALLY TRANSFER").

As per claim 8, Yamada in view of Stancil and May disclose the method of Claim 7,

- further comprising transmitting control information from the first integrated circuit to the second integrated circuit prior to transmitting the second set of programming instructions to a second one of the plurality of ICs (see Yamada FIG 6: S4).

As per claim 9, Yamada in view of Stancil and May disclose the method of Claim 8,

- wherein the control information directs the second one of the plurality of ICs to receive a subsequent transmission of programming instructions (see Yamada FIG 6: S5).

As per claim 10, Yamada discloses in a system including a plurality of integrated circuits (ICs), each IC having a memory for storing at least programming instructions, and a processor coupled to the memory for executing programming instructions stored in the memory; the system further including a single non-volatile memory disposed on the printed circuit board and coupled for memory access to only a first one of the plurality of ICs, a method of downloading code from the single non-volatile memory to each of the plurality of ICs, comprising:

- receiving, at a first one of the plurality of ICs, a first set of data from the single non-volatile memory; storing the first set of data in the memory of the first one of the plurality of ICs (see Yamada FIG 6: S3 and COL 3 LINES 28-46);

- receiving, at the first one of the plurality of ICs, a second set of data from the single non-volatile memory; transmitting the second set of data from the first one of the plurality of ICs to the second one of the plurality of ICs; and storing the second set of data in the memory of the second one of the plurality of ICs; wherein the first and second sets of data comprise program code (see Yamada FIG 6: S5 and COL 3 LINES 28-46).

However, Yamada does not expressly disclose the plurality of ICs disposed on a printed circuit board.

In the same field of endeavor Stancil discloses it is well known to place many components on a motherboard (substrate) (see Stancil COL 5 LINES 5-10).

It would have been obvious to modify Yamada to integrate the components on a motherboard.

The suggestion/motivation for doing so would have been of higher performance systems (see Stancil COL 2 LINES 24-28).

Therefore it would have been obvious to modify Yamada to integrate the components on a motherboard for the benefit higher performance to arrive at the invention as specified in the claims.

However, Yamada and Stancil does not expressly disclose

- test circuitry for providing debugging functionality
- transmitting, using the debugging circuitry, the second set of data from the first one of the plurality of ICs to the second one of the plurality of ICs; and

In the same field of endeavor May discloses

- test circuitry for providing debugging functionality (see May FIG 2: 240),

[The embedded controller is construed as a first integrated circuit and the PLD array is construed as the second integrated circuit.]

- transmitting, using the debugging circuitry, the second set of data from the first one of the plurality of ICs to the second one of the plurality of ICs; and (see May COL 3 LINES 24-41).

It would have been obvious to modify Yamada and Stancil to communicatively couple the first and second integrated circuit through test circuitry as taught by May.

The suggestion/motivation for doing so would have been for the benefit of a test interface (see FIG 2: 'PLD TEST INTERFACE').

Therefore it would have been obvious to modify Yamada and Stancil to communicatively couple the first and second integrated circuit through test circuitry as taught by May for the benefit of a test interface to arrive at the invention as specified in the claims.

As per claim 11, Yamada in view of Stancil and May discloses the method of Claim 10,

- further comprising: executing, in the first IC, at least a portion of the code in the program first set of data (see FIG 6: S6);
- receiving, at the first one of the plurality of ICs, a third set of data from the single non-volatile memory; transmitting the third set of data from the first one of the plurality of ICs to a third one of the plurality of ICs; and storing the third set of data in the memory of the third one of the plurality of ICs (see Stancil FIG 2: 114, 116, 118);

As per claim 12, Yamada in view of Stancil and May disclose the method of Claim 10,

- wherein transmitting the second set of data from the first one of the plurality of ICs to the second one of the plurality of ICs comprises serially shifting data out of the first one of the plurality of ICs via an output terminal; wherein the output terminal is coupled to an input terminal of the second one of the plurality of ICs, the input terminal coupled to circuitry within the second one of the plurality of ICs that is adapted to receive serial data (see Yamada FIG 6: S5 SERIALY).

As per claim 13, Yamada in view of Stancil and May disclose the method of Claim 12,

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- further comprising placing the test circuitry in a test mode (see May FIG 2: PLD TEST INTERFACE) and
- providing transmitting control information from the first one of the plurality of ICs to the second one of the plurality of ICs prior to transmitting the second set of data (see Yamada FIG 6: S4).

As per claim 14, Yamada in view of Stancil and May disclose the method of claim 13.

- wherein the control information is transmitted in accordance with a JTAG standard of communication (see May FIG 2: JTAG).

3. **CLAIMS 15-18** rejected under 35 U.S.C. 103(a) as being unpatentable over Yamada (US Pat No. 5757639) in view of Stancil (US Pat No. 6272584) and Chang (US Pat No. 6484273).

As per claim 15, Yamada discloses an electronic product, comprising: a first integrated circuit having a first processor (see Yamada FIG 1: 1), a first internal memory (see Yamada FIG 1: 3), a first serial communication interface (see Yamada FIG 1: "SERIAL COMMUNICATION"), and an external memory interface (see Yamada FIG 1: 4); an external memory coupled to the external memory interface (see FIG 1: 5 MEMORY CARD); a second integrated circuit having second processor (see FIG 1: 6), a second internal memory (see FIG 1: 8), and a second serial communication interface, the second serial communication interface being coupled to the first serial communication interface (see FIG 1: "SERIAL COMMUNICATION");

However, Yamada does not expressly disclose wherein the first integrated circuit, the external memory, and the second integrated circuit are disposed on a substrate.

In the same field of endeavor Stancil discloses it is well known to place many components on a motherboard (substrate) (see Stancil COL 5 LINES 5-10).

It would have been obvious to modify Yamada to integrate the components on a motherboard.

The suggestion/motivation for doing so would have been of higher performance systems (see Stancil COL 2 LINES 24-28).

Therefore it would have been obvious to modify Yamada to integrate the components on a motherboard for the benefit higher performance to arrive at the invention as specified in the claims.

However, Yamada and Stancil does not expressly disclose

- a first test circuit
- a second test circuit
- wherein the first test circuit and the second test circuit are configured and arranged to communicate debugging information in a test mode and to communicate code images in another mode.

In the same field of endeavor Chang discloses an integrated circuit (see Chang FIG 1) including a test circuit (see Chang FIG 2: 54), wherein the test circuit is configured and arranged to communicate debugging information in a test mode (see COL 2 LINES 58-65) and to communicate code images in another mode (see Chang COL 2 LINES 1-10).

It would have been obvious to modify each of the first and second integrated circuits as taught by Yamada and Stancil to include a test circuit as taught by Chang.

The suggestion/motivation for doing so would have been for the benefit of a non-intrusive development and debug technology (see Chang COL 1 LINES 35-45).

Therefore it would have been obvious to modify Yamada and Stancil to implement a test circuit as taught by Chang for the benefit of debugging technology to arrive at the invention as specified in the claims.

As per claim 16, Yamada in view of Stancil and Chang disclose the electronic product of claim 15,

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- wherein the first processor is coupled to the first internal memory, the first internal memory is adapted to receive a first code image (see Yamada FIG 6: S3), the second processor is coupled to the second internal memory, the second internal memory is adapted to receive a second code image (see FIG 6: S5), and the external memory is a non-volatile memory encoded with the first and second code images (see COL 2 LINES 50-57).

As per claim 17, Yamada in view of Stancil and Chang disclose the electronic product of claim 16,

- wherein the first integrated circuit includes a first hardware facility for performing at least a first function, and the second integrated circuit includes a second hardware facility for performing at least a second function, and the first and second functions are different (see COL 3 LINES 24-45).

As per claim 18, Yamada in view of Stancil and Chang disclose the electronic product of Claim 17, further comprising

- a third integrated circuit, having a third processor, a third internal memory, and a third serial communication interface, the third serial communication interface being coupled to the second serial communication interface, the third processor coupled to the third internal memory, the third internal memory is adapted to receive a third code image, and the external memory further encoded with the third code image (see Stancil FIG 2: 114, 116, 118).

[Stancil discloses configuring plural processing devices using a single EEPROM.]

IV. ACKNOWLEDGMENT OF ISSUES RAISED BY THE APPLICANT

Applicants' arguments filed 17 September 2009 have been fully considered.

RESPONSE TO AMENDMENTS/ARGUMENTS

1st POINT OF ARGUMENT:

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Applicant respectfully traverses the § 103(a) rejections because the cited combination of references lacks correspondence. Regarding claim 1, the references fail to teach or suggest using test circuitry that provides debugging capabilities to also communicate data such as programming instructions between the ICs.

Examiner notes May is relied upon to teach the claimed limitation. May discloses transmitting programming instructions to the PLD array via a PLD controller having a test interface (see May FIG 2).

2nd POINT OF ARGUMENT:

Regarding claim 10, the references fail to teach or suggest using test circuitry for providing debugging functionality to also communicate program code.

Examiner notes May is relied upon to teach the claimed limitation. May discloses transmitting programming instructions to the PLD array via a PLD controller having a test interface (see May FIG 2).

3rd POINT OF ARGUMENT

Regarding claim 15, the references fail to teach or suggest test circuits that are configured to communicate both debugging information and code images, in respective modes.

Examiner notes Chang is relied upon to teach the claimed limitation.

V. CLOSING COMMENTS

STATUS OF CLAIMS IN THE APPLICATION

The following is a summary of the treatment and status of all claims in the application as recommended by M.P.E.P. ' 707.07(i):

Va. CLAIMS REJECTED IN THE APPLICATION

Per the instant office action, claims 1-18 have received a second action on the merits and are subject of a final office action.

For at least the above reasons it is the examiner's position that the applicant's claims are not in condition for allowance.

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Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

VI. DIRECTION OF FUTURE CORRESPONDENCES

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Kalpit Parikh whose telephone number is (571) 270-1173. The examiner can normally be reached on MON THROUGH FRI 7:30 TO 5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Christian Chace can be reached on (571) 272-4190. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

CC/kp /KP/
18 November 2009

/Brian R. Peugh/
Primary Examiner, Art Unit 2187
November 20, 2009